

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	NUNC PRO TUNC ASSIGNMENT								
EFFECTIVE DATE:	02/07/2002								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Mou-Shiung Lin</td><td>02/07/2002</td></tr><tr><td>Jin-Yuan Lee</td><td>02/07/2002</td></tr><tr><td>Ching-Cheng Huang</td><td>02/07/2002</td></tr></tbody></table>		Name	Execution Date	Mou-Shiung Lin	02/07/2002	Jin-Yuan Lee	02/07/2002	Ching-Cheng Huang	02/07/2002
Name	Execution Date								
Mou-Shiung Lin	02/07/2002								
Jin-Yuan Lee	02/07/2002								
Ching-Cheng Huang	02/07/2002								
RECEIVING PARTY DATA									
<table border="1"><tr><td>Name:</td><td>MEGIC Corporation</td></tr><tr><td>Street Address:</td><td>21, R&D 1ST. Rd., Science-Based Industrial Park Hsinchu</td></tr><tr><td>City:</td><td>Hsin-Chu City</td></tr><tr><td>State/Country:</td><td>TAIWAN</td></tr></table>		Name:	MEGIC Corporation	Street Address:	21, R&D 1ST. Rd., Science-Based Industrial Park Hsinchu	City:	Hsin-Chu City	State/Country:	TAIWAN
Name:	MEGIC Corporation								
Street Address:	21, R&D 1ST. Rd., Science-Based Industrial Park Hsinchu								
City:	Hsin-Chu City								
State/Country:	TAIWAN								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>10337673</td></tr></tbody></table>		Property Type	Number	Application Number:	10337673				
Property Type	Number								
Application Number:	10337673								
CORRESPONDENCE DATA									
Fax Number: (703)997-4517 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Phone: 3027291562									
Email: Patent.admin.uspto.cr@naipo.com									
Correspondent Name: WINSTON HSU									
Address Line 1: P.O.BOX 506									
Address Line 4: Merrifield, VIRGINIA 22116									
ATTORNEY DOCKET NUMBER:	MEGP0013USA1								
NAME OF SUBMITTER:	WINSTON HSU								
Total Attachments: 2 source=MEGP0013USA1-ASS#page1.tif									

CH 10337673 \$40.00

500241220

PATENT
REEL: 019026 FRAME: 0338

MEGIC-2001-019C:

ASSIGNMENT

WHEREAS, 1. Mou-Shiung Lin
2. Jin-Yuan Lee
3. Ching-Cheng Huang

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **CHIP STRUCTURE AND PROCESS FOR FORMING THE SAME**

☐ Filed: Serial No.

☒ Executed concurrently with the execution of this instrument

WHEREAS, Megic Corporation
of 21, R&D 1st Rd., Science-Based Industrial Park Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

MEGIC-2001-019G

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Mou-Shiung Lin
Signature

2/7/2002
Date

Sole or First Joint Inventor: Mou-Shiung Lin

Jin-Yuan Lee
Signature

2/7 '02
Date

Second Joint Inventor (if any): Jin-Yuan Lee

Ching-Cheng Huang
Signature

2/7-2002
Date

Third Joint Inventor (if any): Ching-Cheng Huang